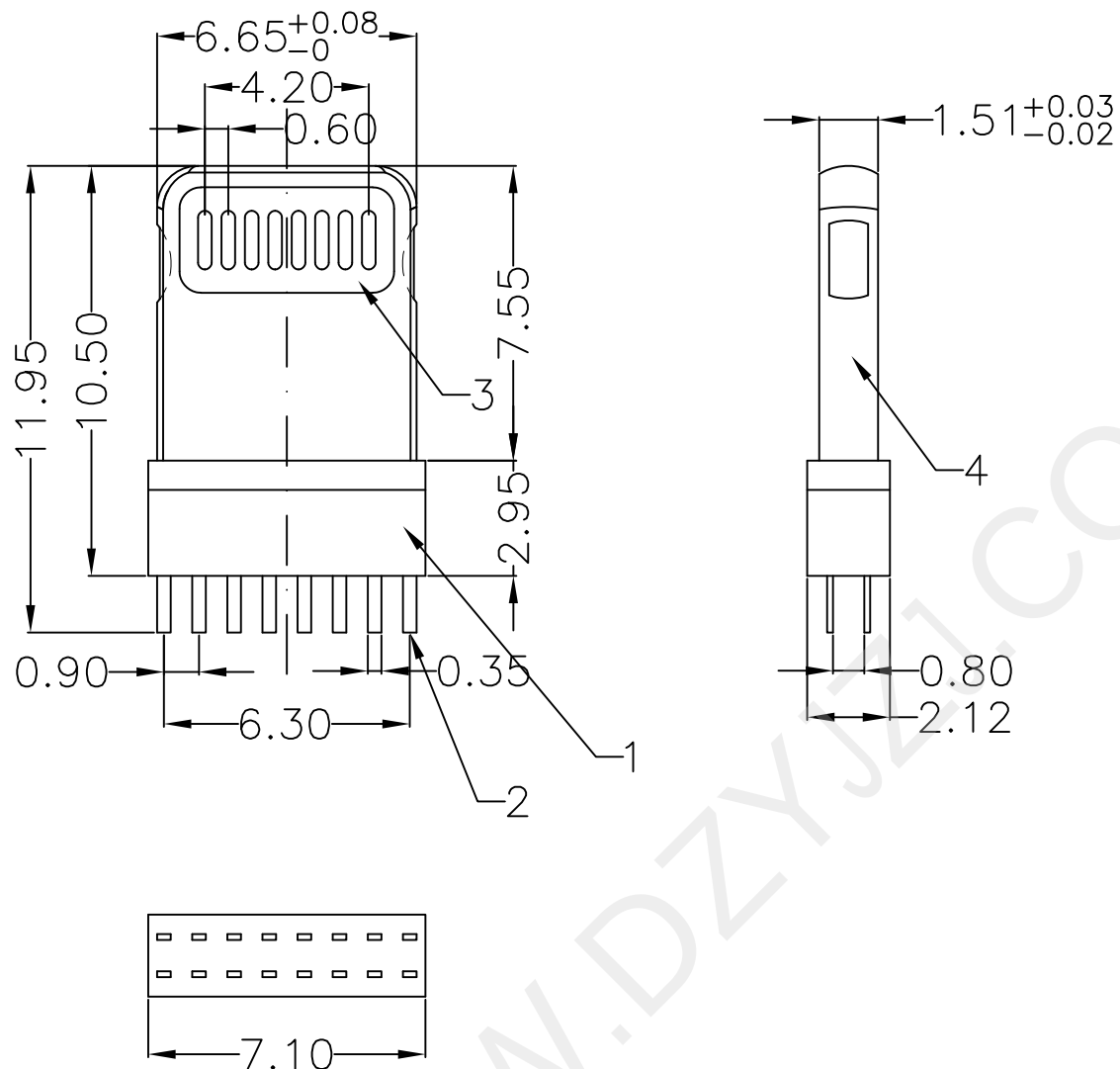




NOTES:

1. MATERIALS:

①: LCP (一次Molding).

②: C2680, T=0.15±0.02mm 镀半金雾锡.

③: ABS 苹果白 (二次Molding).

④: 锌合金

2. 有“*”标志的为重点尺寸.



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 苹果公座8P 夹板0.8	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HVC30-IP0D08-080	MOLD NO.
 UNIT: mm [inch] SCALE: 1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HVC-2602280929	SHEET NO. 1 OF 1